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U.S. DEPARTMENT OF COMMERCE

Atty Docket #:

102079308

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To the Honorable Commission	oner of Patents and Trademarks: Please rec	cord the attached original documents or copy thereof.	
1. Name of conveying	part(ies):	2. Name and address of receiving party(ies)	
James H. Knapp			0/1
Stephen C. St. Germain		Name: Semiconductor Components	Industries, LEC
04	124/02	Internal Address: Patent Administrat	ion Dept A230
3. Nature of conveyan	ce:		
		Street Address: 5005 East McDowell Road	
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Execution date of conveyance:	pril 26, 2002	Additional name(s) & address(es) attached?	Yes No
	(s) or patent number(s):		<del></del>
If this document is bein application is:	ng filed together with a new applica	ation, the execution date of the A	pril 26, 2002
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5. Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of applications and patents involved: 1	
Name:	Semiconductor Components Industries, LLC	7. Total fee (37 C.F.R. 3.41)	\$ <u>40.00</u>
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City, State, Zip: Phoenix, AZ 85082-2890		8. Deposit account number: 501086 (Attach duplicate copy of this page if paying by deposit account)	
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original document.  James J. Stipanuk	<b>₹</b> 44,358	In I til	April 26, 2002
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## ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, James H. Knapp of Gilbert, AZ; and Stephen C. St. Germain of Scottsdale, AZ, have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a corporation of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States of America in and to certain inventions relating to improvements in <a href="STRUCTURE AND METHOD OF FORMING A MULTIPLE LEADFRAME SEMICONDUCTOR DEVICE">STRUCTURE AND METHOD OF FORMING A MULTIPLE LEADFRAME SEMICONDUCTOR DEVICE</a> (Attorney Docket No. <a href="ONS00362">ONS00362</a>), described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

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We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance. Stephen C. St. Germain James H. Knapp ) STATE OF ARIZONA ss.: COUNTY OF MARICOPA ) Linda M. Lee , a Notary Public in and for the County and State aforesaid, do hereby certify that James H. Knapp and Stephen C. St. Germain, whose name(s) are subscribed to the foregoing instrument, appeared before me this day in person and acknowledged that they signed, sealed and delivered the instrument as their free and voluntary act and deed for the uses and purposes therein set forth. 26th day of April, 2002. Given under my hand and notarial seal this Anda M. Lee

My commission expires on 9/24/2004 LINDA M. LEE NOTARY PUBLIC-ARIZONA MARICOPA COUNTY My Comm. Expires Sept. 24, 2004

Address correspondence concerning this document to: Semiconductor Components Industries, LLC, Patent Administration Dept - MD A700, P.O. Box 62890, Phoenix, AZ 85082-2890.

RECORDED: 04/26/2002